



PDS3200

3A HIGH VOLTAGE SCHOTTKY BARRIER RECTIFIER PowerDI® 5

Features

- Guard Ring Die Construction for Transient Protection
- Low Forward Voltage Drop
- Very Low Leakage Current
- Highly Stable Oxide Passivated Junction
- High Forward Surge Current Capability
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

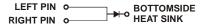
Mechanical Data

- Case: PowerDI[®]5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Polarity: See Diagram
- Weight: 0.096 grams (approximate)





Bottom View



Note: Pins Left & Right must be electrically connected at the printed circuit board.

Top View

Ordering Information (Note 4)

Part Number	Qualification	Case	Packaging
PDS3200-13	Commercial	PowerDI [®] 5	5000/Tape & Reel
PDS3200-7	Commercial	PowerDI [®] 5	1500/Tape & Reel
PDS3200Q-13	Automotive	PowerDI [®] 5	5000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html

Marking Information



S3200 = Product type marking code

| | = Manufacturers' code marking

YYWW = Date code marking

YY = Last digit of year (ex: 04 for 2004)

WW = Week code (01 - 53)

K = Factory Designator



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	200	V
RMS Reverse Voltage	V _{R(RMS)}	141	V
Average Rectified Output Current (See also figure 5)	lo	3	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load	I _{FSM}	180	Α

Thermal Characteristics

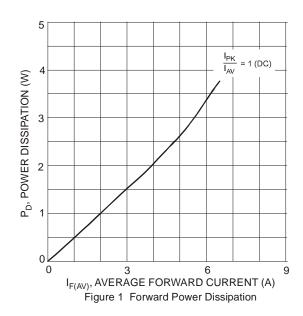
Characteristic	Symbol	Тур	Max	Unit
Thermal Resistance Junction to Soldering Point	R∙ _{JS}	_	2.0	°C/W
Thermal Resistance Junction to Ambient Air (Note 5) T _A = +25°C	R∙JA	75	_	°C/W
Thermal Resistance Junction to Ambient Air (Note 6) T _A = +25°C	R∙ _{JA}	60	_	°C/W
Thermal Resistance Junction to Ambient Air (Note 7) T _A = +25°C	R∙JA	45		°C/W
Operating Temperature Range	TJ	-65 to +150		°C
Storage Temperature Range	T _{STG}	-65 to	+175	°C

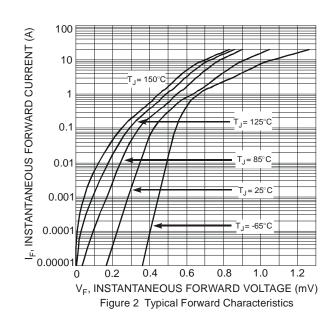
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 8)	$V_{(BR)R}$	200	_	_	V	$I_R = 10\mu A$
			0.75	0.78	V	I _F = 3A, T _S = +25°C
Forward Voltage	V	—	0.59	0.64		$I_F = 3A, T_S = +125$ °C
Forward Vollage	V_{F}	_	0.82	0.88		$I_F = 6A$, $T_S = +25$ °C
		_	0.66	0.71		I _F = 6A, T _S = +125°C
Reverse Leakage Current (Note 8)	1-	_	1	10	μΑ	$T_S = +25^{\circ}C, V_R = 200V$
Reverse Leakage Current (Note 6)	IR	_	8.0	4.5	mA	$T_S = +125$ °C, $V_R = 200$ V

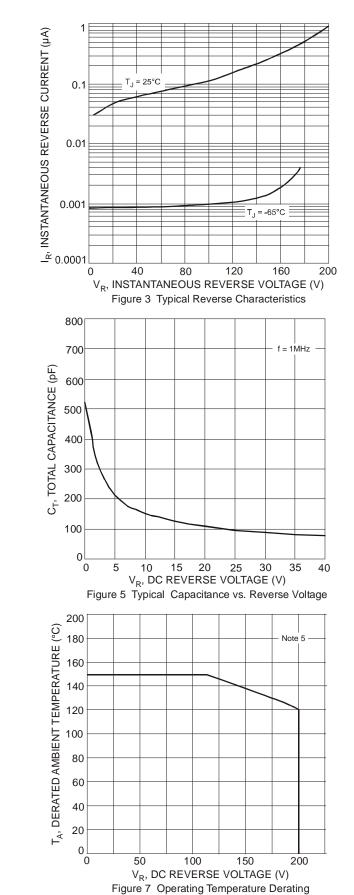
Notes:

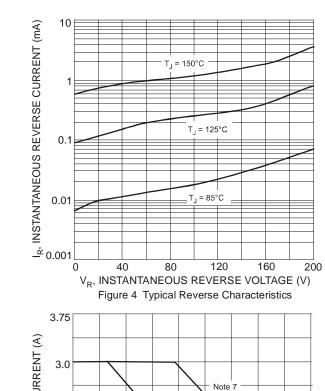
- 5. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
- 6. Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
- 7. Polymide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.
- 8 Short duration pulse test used to minimize self-heating effect.

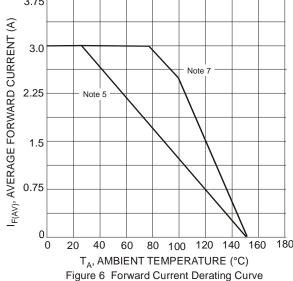






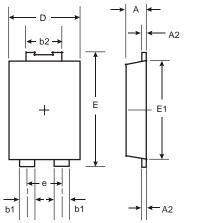


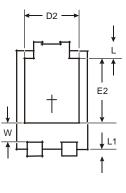






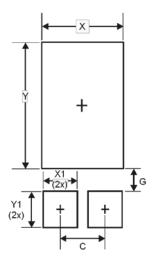
Package Outline Dimensions





PowerDI [®] 5			
Dim	Min	Max	
Α	1.05	1.15	
A2	0.33	0.43	
b1	0.80	0.99	
b2	1.70	1.88	
D	3.90	4.05	
D2	3.054 Typ		
Е	6.40	6.60	
е	1.84	Тур	
E1	5.30	5.45	
E2	3.549 Typ		
L	0.75	0.95	
L1	0.50	0.65	
W	1.10	1.41	
All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
С	1.840
G	0.852
Х	3.360
X1	1.390
Υ	4.860
Y1	1.400



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